



LOW CAPACITANCE BIDIRECTIONAL TVS DIODE

D5V0L1B2S9

Product Summary

V _{BR min}	I _{pp max}	C _{in typ}
6V	6A	15pF

Description

This new generation TVS is designed to protect sensitive electronics from the damage due to ESD. The combination of small size and high ESD surge capability make it ideal for use in portable applications such as cellular phones, digital cameras and MP3 players.

Applications

- Cellular Handsets
- Portable Electronics
- Computers and Peripheral

Features

- Provides ESD Protection per IEC 61000-4-2 Standard: Air ±30kV, Contact ±30kV
- 1 Channel of ESD Protection
- Low Channel Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: SOD923
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead-Free Plating). Solderable per MIL-STD-202, Method 208@3)
- Weight: 0.001 grams (Approximate)

SOD923



Top View



Device Schematic

Ordering Information (Note 4)

Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
D5V0L1B2S9-7	Standard	S/S	7	8	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain < 900ppm bromine, < 900ppm chlorine (< 1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

S/S

S / S = Product Type Marking Code



Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P_PP	84	W	8/20µs, per Figure 1
Peak Pulse Current	I _{PP}	6	Α	8/20µs, per Figure 1
ESD Protection – Contact Discharge	V _{ESD_Contact}	±30	kV	IEC 61000-4-2 Standard
ESD Protection – Air Discharge	V _{ESD_Air}	±30	kV	IEC 61000-4-2 Standard

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	P _D	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	R _{θJA}	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Standoff Voltage	V_{RWM}	_	_	5	V	_
Channel Leakage Current (Note 6)	I _{RM}	_	10	100	nA	V _{RWM} = 5V
Clamping Voltage, Positive Transients		_	7.0	9.0	V	$I_{PP} = 1A, t_p = 8/20 \mu S$
	.,,	_	8.7	10.7		$I_{PP} = 3A, t_p = 8/20\mu S$
	V _{CL}	_	10.5	12.0		$I_{PP} = 5A, t_p = 8/20\mu S$
		_	11.5	14.0		$I_{PP} = 6A, t_p = 8/20\mu S$
Breakdown Voltage	V_{BR}	6	7	8	V	I _R = 1mA
Differential Resistance	R _{DIF}	_	0.2	_	Ω	$I_R = 1A$, $t_p = 8/20 \mu S$
Channel Input Capacitance	CIN	_	15	20	pF	$V_R = 0V$, $f = 1MHz$

Notes:

- 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website
- at http://www.diodes.com.6. Short duration pulse test used to minimize self-heating effect.

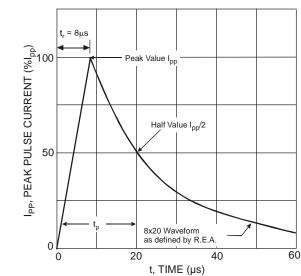


Figure 1 Pulse Waveform

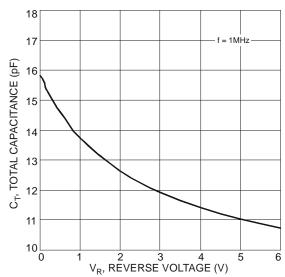
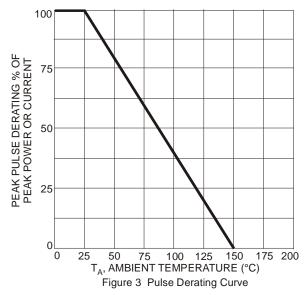


Figure 2 Typical Total Capacitance vs. Reverse Voltage





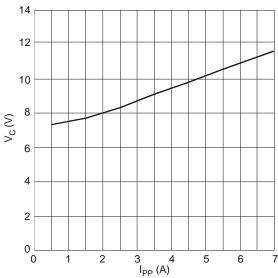


Figure 5 Typical Peak Clamping Voltage V_C vs. Peak Pulse Current IPP

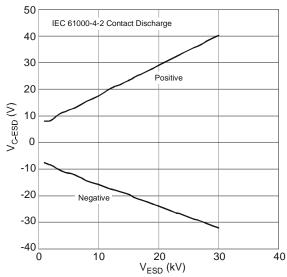


Figure 7 Typical Clamping Voltage vs. Contact Discharge Voltage

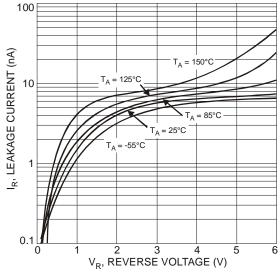


Figure 4 Typical Reverse Characteristics

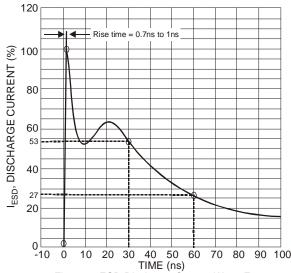


Figure 6 ESD Discharge Current Wave Form IEC 6100-4-2 (330Ω/150pF)

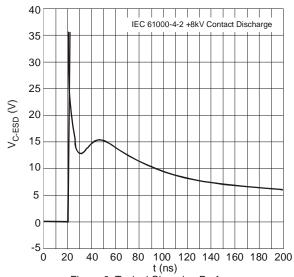
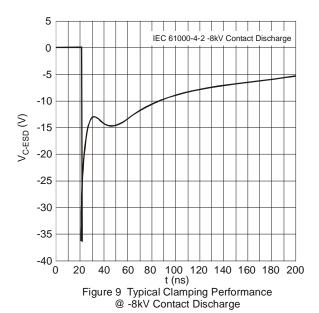


Figure 8 Typical Clamping Performance

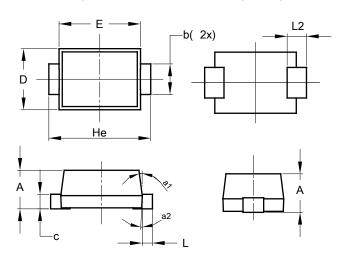
@ 8kV Contact Discharge





Package Outline Dimensions

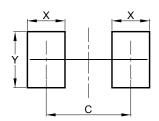
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



SOD923						
(0.	(0.3mm Lead Width)					
Dim	Min	Max	Тур			
Α	0.34	0.40	0.37			
b	0.25	0.35	0.30			
С	0.05	0.15	0.10			
D	0.55	0.65	0.60			
Е	0.75	0.85	0.80			
Не	0.95	1.05	1.00			
L	0.05	0.15	0.10			
L2	L2 0.190 REF					
a1	0°	8°	7°			
a2	2°	4°	3°			
All Dimensions in mm						

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for latest version.



Dimensions	Value (in mm)		
С	0.900		
Х	0.400		
γ	0.600		



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